

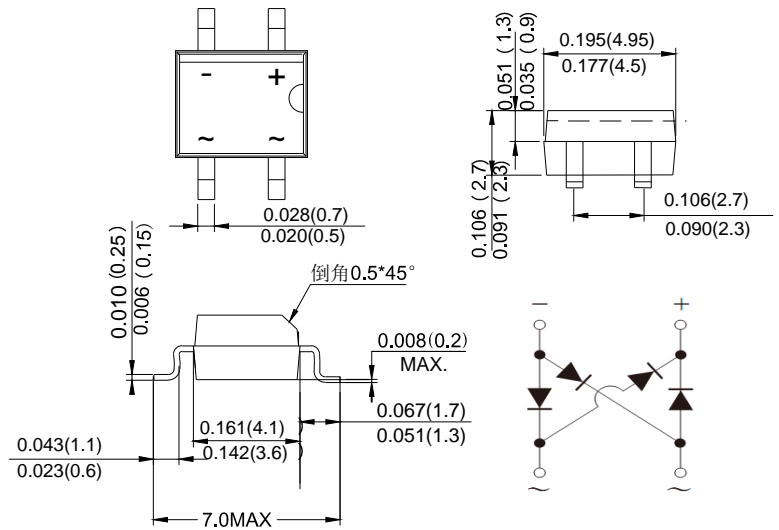
### MBS

#### FEATURES:

- Reverse Voltage - 40 to 200 V
- Forward Current - 3 A
- High Surge Current Capability
- Designed for Surface Mount Application

#### MECHANICAL DATA

- Case: MBS
- Terminals: Solderable per MIL-STD-750
- Approx. Weight: 100mg / 0.0035oz



#### Maximum Ratings and Electrical characteristics

dimensions in inches and (millimeters)

Ratings at 25 °C ambient temperature unless otherwise specified.

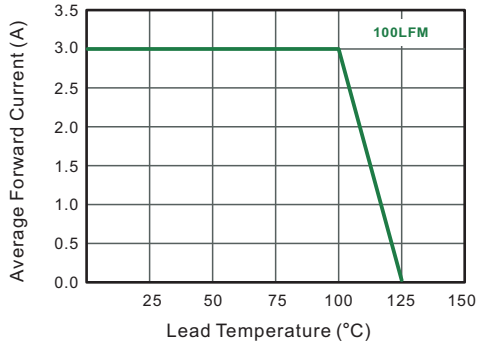
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB34S	MB36S	MB38S	MB310S	MB320S	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	40	60	80	100	200	V
Maximum RMS voltage	$V_{RMS}$	28	42	56	70	140	V
Maximum DC Blocking Voltage	$V_{DC}$	40	60	80	100	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0					A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	$I_{FSM}$	80		70			A
Max Instantaneous Forward Voltage at 3 A	$V_F$	0.55	0.70	0.85		0.95	V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 100^\circ\text{C}$	$I_R$	0.5 10	0.3 5			mA	
Typical Junction Capacitance <sup>1)</sup>	$C_j$	250	160			pF	
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$	60					$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	$T_j$	-55 ~ +125					$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55 ~ +150					$^\circ\text{C}$

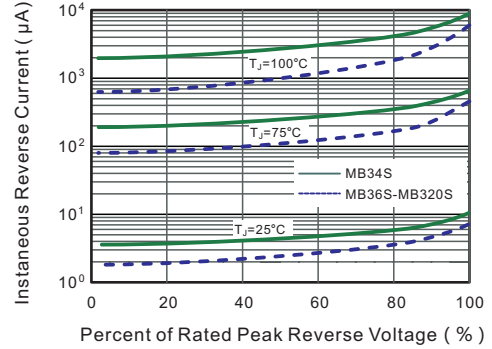
Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with  $4 \times (5 \times 5\text{mm}^2)$  copper pad.

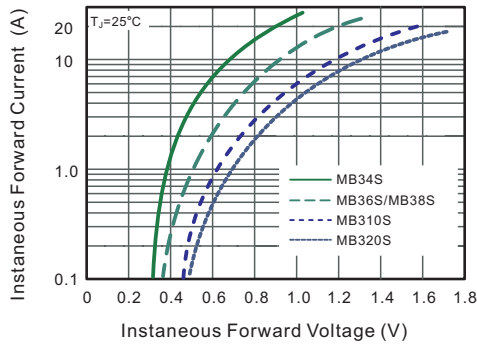
**Fig.1 Forward Current Derating Curve**



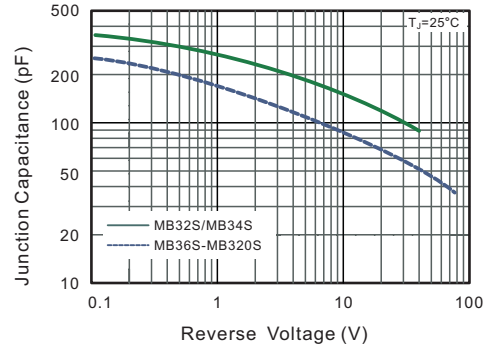
**Fig.2 Typical Reverse Characteristics**



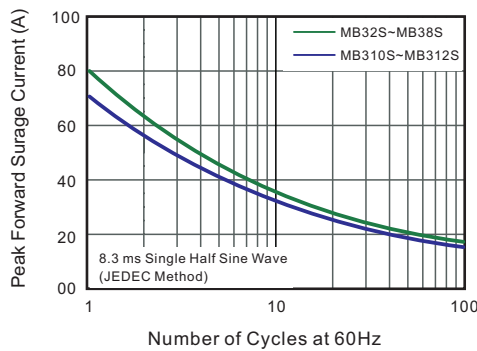
**Fig.3 Typical Forward Characteristic**



**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



**Fig.6- Typical Transient Thermal Impedance**

